

# 4A, 100V - 200V Ultra Fast Surface Mount Rectifier

#### **FEATURES**

- AEC-Q101 qualified
- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- High frequency switching
- DC/DC
- Snubber

#### **MECHANICAL DATA**

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.088g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	4	Α	
$V_{RRM}$	100 - 200	V	
I <sub>FSM</sub>	130	Α	
T <sub>J MAX</sub>	175 °C		
Package	DO-214AA (SMB)		
Configuration	Single die		









DO-214AA (SMB)



PARAMETER		SYMBOL	PU4BBH	PU4DBH	UNIT
Marking code on the device			PU4BB	PU4DB	
Repetitive peak reverse voltage		$V_{RRM}$	100	200	V
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	70	140	V
Forward current		I <sub>F</sub>	4		Α
Surge peak forward current single half	t = 8.3ms	,	130 290		A
sine-wave superimposed on rated load	t = 1.0ms	I <sub>FSM</sub>			
Junction temperature		TJ	-55 to +175		°C
Storage temperature		T <sub>STG</sub>	-55 to +175		°C



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	R <sub>OJL</sub>	13	°C/W	
Junction-to-ambient thermal resistance	R <sub>OJA</sub>	69	°C/W	
Junction-to-case thermal resistance	R <sub>eJC</sub>	17	°C/W	

Thermal Performance Note: Units mounted on PCB (10mm x 10mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
(1)	I <sub>F</sub> = 2A, T <sub>J</sub> = 25°C		0.79	-	V
	I <sub>F</sub> = 4A, T <sub>J</sub> = 25°C	\/	0.84	0.93	V
Forward voltage <sup>(1)</sup>	I <sub>F</sub> = 2A, T <sub>J</sub> = 125°C	$V_{F}$	0.64	-	V
	I <sub>F</sub> = 4A, T <sub>J</sub> = 125°C		0.70	-	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 25°C	ı	-	2	μA
	T <sub>J</sub> = 125°C	l <sub>R</sub>	-	10	μA
Junction capacitance	1MHz, $V_R = 4.0V$	CJ	78	-	pF
Payaraa raaayary tima	$I_F = 0.5A$ , $I_R = 1.0A$ , $I_{rr} = 0.25A$	4	-	25	ns
Reverse recovery time	$I_F = 1.0A$ , di/dt = 50A/ $\mu$ s, $V_R = 30V$	t <sub>rr</sub>	31	-	
Reverse recovery current		I <sub>RM</sub>	4.9	-	Α
Reverse recovery charge	$I_F = 4.0A$ , di/dt = 200A/ $\mu$ s, $V_R = 100V$	Q <sub>rr</sub>	57	-	nC
Reverse recovery time		t <sub>rr</sub>	24	-	ns

### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING	
PU4xBH	DO-214AA (SMB)	3,000/ Tape & Reel	

### Notes:

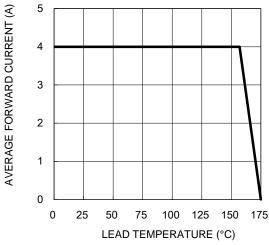
1. "x" defines voltage from 100V(PU4BBH) to 200V(PU4DBH)



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve



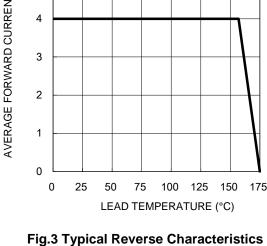


Fig.2 Typical Junction Capacitance

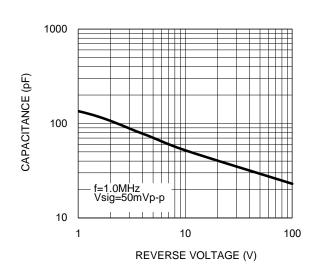
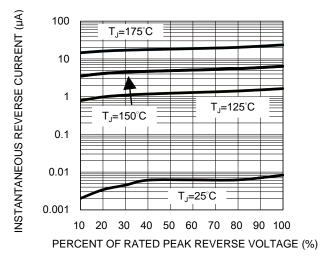


Fig.4 Typical Forward Characteristics



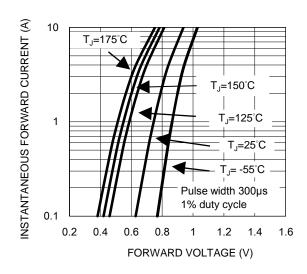
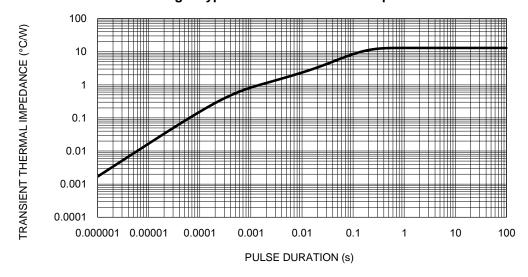


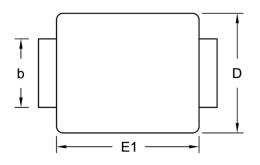
Fig.5 Typical Transient Thermal Impedance

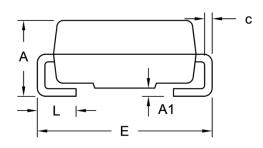




## **PACKAGE OUTLINE DIMENSIONS**

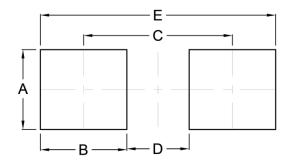
# DO-214AA (SMB)





DIM.	Unit (mm)		Unit	(inch)	
Dilvi.	Min.	Max.	Min.	Max.	
Α	1.95	2.65	0.077	0.104	
A1	0.05	0.20	0.002	0.008	
b	1.95	2.20	0.077	0.087	
С	0.15	0.31	0.006	0.012	
D	3.30	3.95	0.130	0.156	
E	5.10	5.60	0.201	0.220	
E1	4.05	4.60	0.159	0.181	
L	0.75	1.60	0.030	0.063	

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	2.30	0.091
В	2.50	0.098
С	4.30	0.169
D	1.80	0.071
E	6.80	0.268

## **MARKING DIAGRAM**



P/N = Marking Code
G = Green Compound
YW = Date Code
F = Factory Code



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